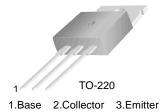


TIP140T/141T/142T

Monolithic Construction With Built In Base-Emitter Shunt Resistors

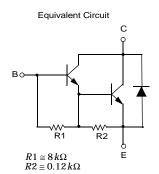
- High DC Current Gain : h_{FE} = 1000 @ V_{CE} = 4V, I_{C} = 5A (Min.)
- Industrial Use
- Complement to TIP145T/146T/147T



NPN Epitaxial Silicon Darlington Transistor

Absolute Maximum Ratings T_C=25°C unless otherwise noted

Symbol	Parameter	Value	Units
V_{CBO}	Collector-Base Voltage : TIP140T	60	V
	: TIP141T	80	V
	: TIP142T	100	V
	Collector-Emitter Voltage : TIP140T	60	V
V_{CEO}	: TIP141T	80	V
	: TIP142T	100	V
V _{EBO}	Emitter-Base Voltage	5	V
I _C	Collector Current (DC)	10	Α
I _{CP}	Collector Current (Pulse)	15	Α
I _B	Base Current (DC)	0.5	Α
P _C	Collector Dissipation (T _C =25°C)	80	W
TJ	Junction Temperature	150	°C
T _{STG}	Storage Temperature	- 65 ~ 150	°C



Electrical Characteristics $T_C=25$ °C unless otherwise noted

Symbol	Parameter	Test Condition	Min.	Тур.	Max.	Units
V _{CEO} (sus)	Collector-Emitter Sustaining Voltage : TIP140T : TIP141T : TIP142T	I _C = 30mA, I _B = 0	60 80 100			V V
I _{CEO}	Collector Cut-off Current : TIP140T : TIP141T : TIP142T	$V_{CE} = 30V, I_{B} = 0$ $V_{CE} = 40V, I_{B} = 0$ $V_{CE} = 50V, I_{B} = 0$			2 2 2	mA mA mA
I _{CBO}	Collector Cut-off Current : TIP140T : TIP141T : TIP142T	$V_{CB} = 60V, I_{E} = 0$ $V_{CB} = 80V, I_{E} = 0$ $V_{CB} = 100V, I_{E} = 0$			1 1 1	mA mA mA
I _{EBO}	Emitter Cut-off Current	$V_{BE} = 5V, I_{C} = 0$			2	mA
h _{FE}	DC Current Gain	$V_{CE} = 4V, I_{C} = 5A$ $V_{CE} = 4V, I_{C} = 10A$	1000 500			mA
V _{CE} (sat)	Collector-Emitter Saturation Voltage	I _C = 5A, I _B = 10mA I _C = 10A, I _B = 40mA			2 3	V V
V _{BE} (sat)	Base-Emitter Saturation Voltage	$I_C = 10A, I_B = 40mA$			3.5	V
V _{BE} (on)	Base-Emitter ON Voltage	$V_{CE} = 4V, I_{C} = 10A$			3	V
t _D	Delay Time	$V_{CC} = 30V, I_{C} = 5A$		0.15		μs
t _R	Rise Time	I _{B1} = 20mA		0.55		μs
t _{STG}	Storage Time	$I_{B2} = -20 \text{mA}$		2.5		μs
t _F	Fall Time	$R_L = 6\Omega$		2.5		μs

Typical Characteristics

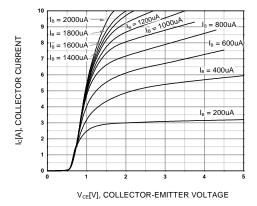


Figure 1. Static Characteristic

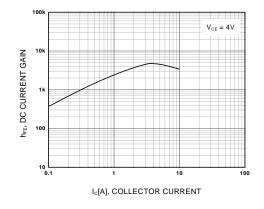


Figure 2. DC current Gain

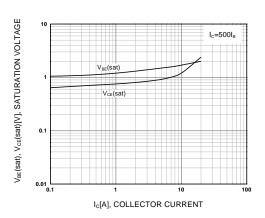


Figure 3. Collector-Emitter Saturation Voltage Base-Emitter Saturation Voltage

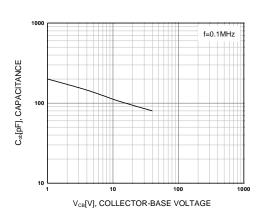


Figure 4. Collector Output Capacitance

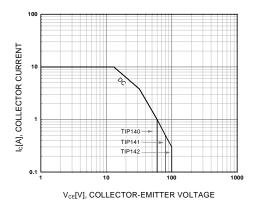


Figure 5. Safe Operating Area

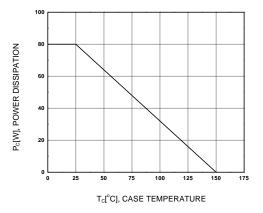
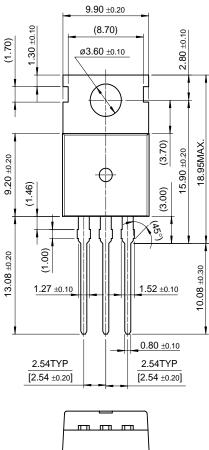


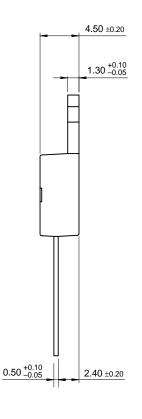
Figure 6.

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Package Demensions

TO-220





10.00 ±0.20

Dimensions in Millimeters

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